MJE344G

Plastic NPN Silicon Medium-Power Transistor

This device is useful for medium voltage applications requiring high f_T such as converters and extended range amplifiers.

Features

• These Devices are Pb-Free and are RoHS Compliant*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V _{CEO}	200	Vdc
Collector-Base Voltage	V _{CB}	200	Vdc
Emitter Base Voltage	V _{EB}	5.0	Vdc
Collector Current – Continuous	I _C	500	mAdc
Base Current	I _B	250	mAdc
Total Power Dissipation @ T _C = 25°C Derate above 25°C	P _D	20 0.16	W mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

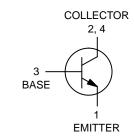
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$\theta_{\sf JC}$	6.25	°C/W



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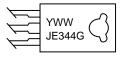
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0.5 AMPERE POWER TRANSISTORS NPN SILICON 150-200 VOLTS, 20 WATTS





MARKING DIAGRAM



Y = Year

WW = Work Week

JE344 = Device Code

G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
MJE344G	TO-225 (Pb-Free)	500 Units/Box

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MJE344G

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Sustaining Voltage ($I_C = 1.0 \text{ mAdc}, I_B = 0$)	200	-	Vdc	
Collector Cutoff Current (V _{CE} = 200 Vdc, I _B = 0)	I _{CEO}	-	1.0	mAdc
Collector Cutoff Current (V _{CB} = 200 Vdc, I _E = 0)	I _{CBO}	-	0.1	mAdc
Emitter Cutoff Current (V _{EB} = 5.0 Vdc, I _C = 0)	I _{EBO}	-	0.1	mAdc
ON CHARACTERISTICS				
DC Current Gain (I _C = 50 mAdc, V _{CE} = 10 Vdc)	h _{FE}	30	300	-
Collector–Emitter Saturation Voltage (I _C = 50 mAdc, I _B = 5.0 mAdc)	V _{CE(sat)}	-	1.0	Vdc
Base–Emitter On Voltage (I _C = 50 mAdc, V _{CE} = 10 Vdc)	V _{BE(on)}	-	1.0	Vdc
DYNAMIC CHARACTERISTICS				
Current–Gain – Bandwidth Product (I _C = 50 mAdc, V _{CE} = 25 Vdc, f = 10 MHz)	f _T	15	_	MHz
Output Capacitance (V _{CB} = 20 Vdc, I _E = 0, f = 100 kHz)	C _{ob}	_	15	pF
Small–Signal Current Gain (I _C = 50 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz)	h _{fe}	25	_	_

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

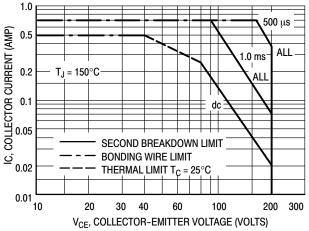
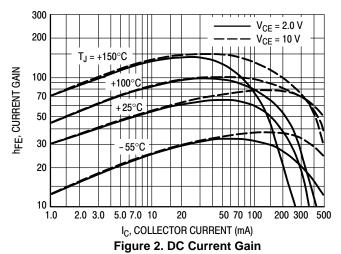


Figure 1. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation then the curves indicate.

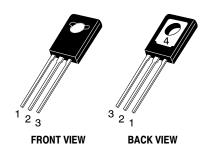
The data of Figure 1 is based on $T_{J(pk)} = 150^{\circ}C$; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}C$. At high case temperatures, thermal limitations will reduce the power that can be handled to values less then the limitations imposed by second breakdown.



1.0 0.8 $V_{BE(sat)} @ I_C/I_B = 10$ VOLTAGE (VOLTS) V_{BE} @ V_{CE} = 10 V 0.4 $V_{CE(sat)} @ I_C/I_B = 10$ 0.2 $T_J = +25^{\circ}C$ $I_{C}/I_{B} = 5.0$ 10 20 50 200 300 I_C, COLLECTOR CURRENT (mA) Figure 3. "On" Voltages

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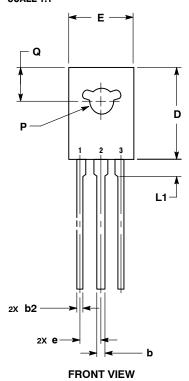


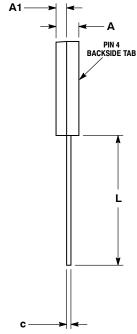


TO-225 CASE 77-09 **ISSUE AD**

DATE 25 MAR 2015

SCALE 1:1



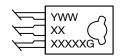


SIDE VIEW

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS. 3. NUMBER AND SHAPE OF LUGS OPTIONAL.

	MILLIMETERS				
DIM	MIN MAX				
Α	2.40	3.00			
A1	1.00	1.50			
b	0.60	0.90			
b2	0.51	0.88			
C	0.39	0.63			
D	10.60	11.10			
E	7.40	7.80			
е	2.04	2.54			
L	14.50	16.63			
L1	1 1.27 2.				
P	2.90	3.30			
Q	3.80 4.20				

GENERIC MARKING DIAGRAM*



= Year

ww = Work Week

XXXXX = Device Code

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1: PIN 1. 2., 4. 3.	EMITTER COLLECTOR BASE	STYLE 2: PIN 1. 2., 4. 3.	STYLE 3: PIN 1. 2., 4. 3.	BASE COLLECTOR EMITTER	STYLE 4: PIN 1. 2., 4. 3.	ANODE 1 ANODE 2 GATE	2., 4.	MT 1 MT 2 GATE
STYLE 6: PIN 1. 2., 4. 3.	CATHODE GATE ANODE	STYLE 7: PIN 1. 2., 4. 3.	STYLE 8: PIN 1. 2., 4. 3.	SOURCE GATE DRAIN	STYLE 9: PIN 1. 2., 4. 3.	GATE DRAIN SOURCE	STYLE 10: PIN 1. 2., 4. 3.	SOURCE DRAIN

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DESCRIPTION:	TO-225		PAGE 1 OF 1		

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